

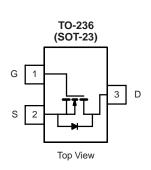
SQ2318AES-T1_GE3-VB Datasheet N-Channel 40 V (D-S) MOSFET

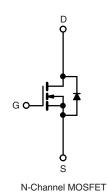
| PRODUCT SUMMARY | | | | |
|--|--------|--|--|--|
| V _{DS} (V) | 40 | | | |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$ | 0.035 | | | |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$ | 0.040 | | | |
| I _D (A) | 4.8 | | | |
| Configuration | Single | | | |

FEATURES

- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested







| ABSOLUTE MAXIMUM RATING | S (T _C = 25 °C, unles | s otherwise noted | i) | | |
|--|----------------------------------|-----------------------------------|-------------|------|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | V_{DS} | 40 | ., | |
| Gate-Source Voltage | | V _{GS} | ± 20 | V | |
| Continuous Busin Comment | T _C = 25 °C | | 4.8 | | |
| Continuous Drain Current | T _C = 125 °C | l _D | 3.6 | | |
| Continuous Source Current (Diode Conduction) | | I _S | 3.8 | Α | |
| Pulsed Drain Current ^a | | I _{DM} | 20 | | |
| Single Pulse Avalanche Current | L = 0.1 mH | l _{AS} | 13 | | |
| Single Pulse Avalanche Energy | L = U.1 Min | E _{AS} | 8 | mJ | |
| Maximum Power Dissipation ^a | T _C = 25 °C | 5 °C | 3 | W | |
| | T _C = 125 °C | P_{D} | 1 | VV | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to +175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------|------------------------|------------|-------|------|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Junction-to-Ambient | PCB Mount ^b | R_{thJA} | 166 | °C/W | |
| Junction-to-Foot (Drain) | | R_{thJF} | 50 | C/VV | |

Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. When mounted on 1" square PCB (FR-4 material).

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| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|--------------------------|--|---|------|-------|-------|--------------|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = | = 0 V, I _D = 250 μA | 40 | - | - | V |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | - V _{GS} , I _D = 250 μA | 1.5 | 2.0 | 2.5 | V |
| Gate-Source Leakage | I _{GSS} | V _{DS} = | 0 V, V _{GS} = ± 20 V | - | - | ± 100 | nA |
| | | V _{GS} = 0 V | V _{DS} = 40 V | - | - | 1 | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V | V _{DS} = 40 V, T _J = 125 °C | - | - | 50 | μΑ |
| | | $V_{GS} = 0 V$ | V _{DS} = 40 V, T _J = 175 °C | - | - | 150 | |
| On-State Drain Current ^a | I _{D(on)} | V _{GS} = 10 V | $V_{DS} \ge 5 V$ | 10 | - | - | Α |
| | | V _{GS} = 10 V | I _D = 3.9 A | - | 0.035 | - | V 5 V 000 nA |
| Drain-Source On-State Resistance ^a | В | V _{GS} = 10 V | I _D = 3.9 A, T _J = 125 °C | - | 0.045 | - | |
| Drain-Source On-State nesistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 3.9 A, T _J = 175 °C | - | 0.065 | - | |
| | | V _{GS} = 4.5 V | I _D =3.3 A | - | 0.040 | - | |
| Forward Transconductanceb | 9 _{fs} | V _{DS} = 15 V, I _D =3.9 A | | - | 30 | - | S |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | - | 442 | 553 | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 V$ | V _{DS} = 20 V, f = 1 MHz | - | 79 | 99 | pF |
| Reverse Transfer Capacitance | C _{rss} | | | - | 37 | 46 | |
| Total Gate Charge ^c | Qg | | | - | 8.7 | 13 | |
| Gate-Source Charge ^c | Q _{gs} | V _{GS} = 10 V | $V_{DS} = 20 \text{ V}, I_{D} = 3.9 \text{ A}$ | - | 1.4 | - | nC |
| Gate-Drain Charge ^c | Q_{gd} | | | - | 1.6 | - | |
| Gate Resistance | R_{g} | | f = 1 MHz | 1.5 | 3.0 | 4.5 | Ω |
| Turn-On Delay Time ^c | t _{d(on)} | | | - | 7.5 | 11 | |
| Rise Time ^c | t _r | $V_{DD} = 20 \text{ V}, R_L = 20 \Omega$ - 8.4 $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ - 12 | | 8.4 | 13 | | |
| Turn-Off Delay Time ^c | t _{d(off)} | | | 18 | 113 | | |
| Fall Time ^c | t _f | | | - | 5.7 | 8.5 | |
| Source-Drain Diode Ratings and Chara | acteristics ^b | | | | | | |
| Pulsed Current ^a | I _{SM} | | | - | - | 32 | Α |
| Forward Voltage | V_{SD} | I _F = 5.4 A, V _{GS} = 0 V | | - | 0.8 | 1.2 | V |

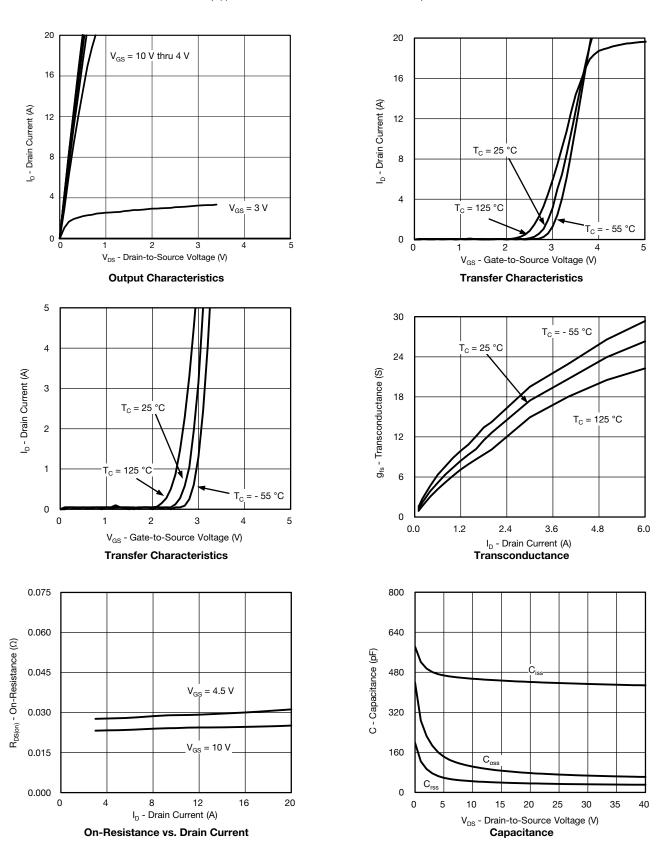
Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

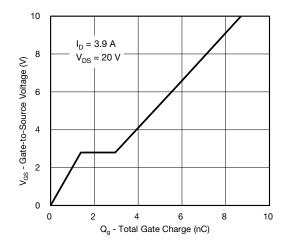


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

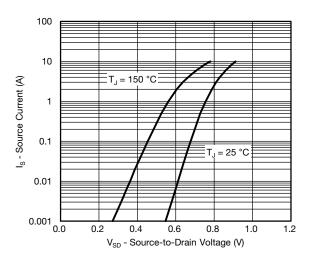




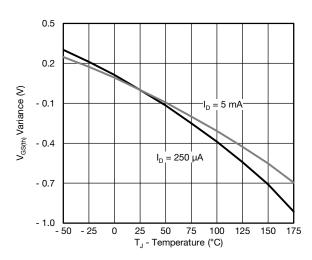
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



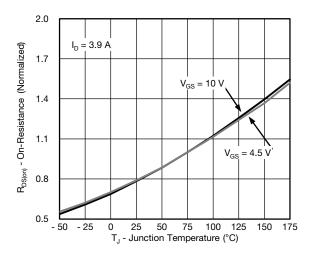
Gate Charge



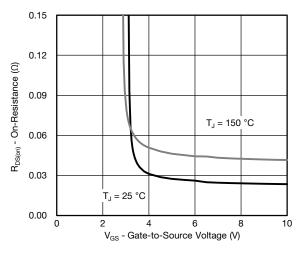
Source Drain Diode Forward Voltage



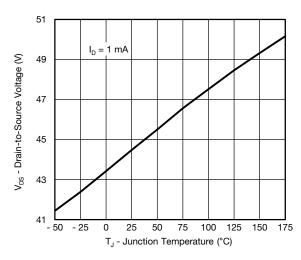
Threshold Voltage



On-Resistance vs. Junction Temperature



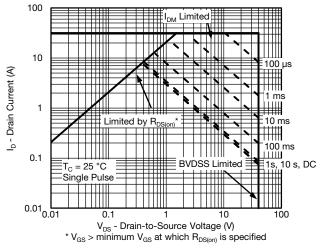
On-Resistance vs. Gate-to-Source Voltage



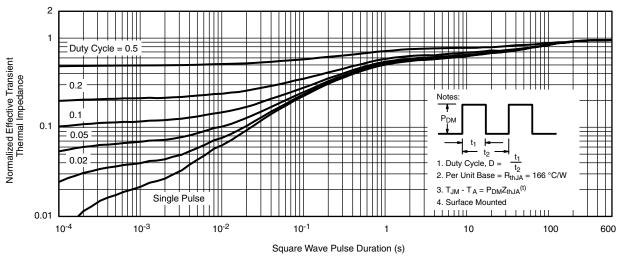
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



Safe Operating Area

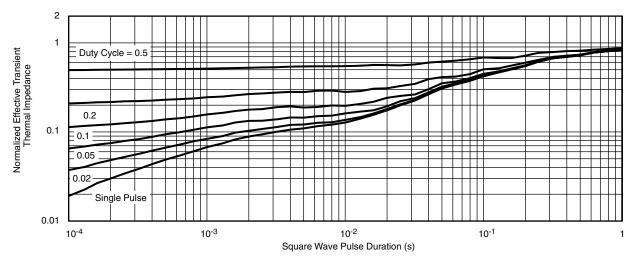


Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



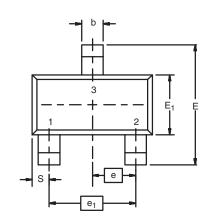
Normalized Thermal Transient Impedance, Junction-to-Foot

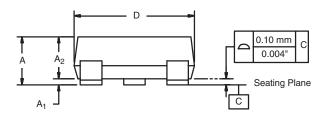
Note

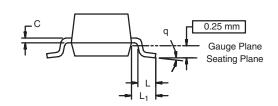
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



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| Dim | MILLII | METERS | INCHES | | |
|----------------|----------|--------|------------|-------|--|
| | Min | Max | Min | Max | |
| Α | 0.89 | 1.12 | 0.035 | 0.044 | |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.004 | |
| A ₂ | 0.88 | 1.02 | 0.0346 | 0.040 | |
| b | 0.35 | 0.50 | 0.014 | 0.020 | |
| С | 0.085 | 0.18 | 0.003 | 0.007 | |
| D | 2.80 | 3.04 | 0.110 | 0.120 | |
| E | 2.10 | 2.64 | 0.083 | 0.104 | |
| E ₁ | 1.20 | 1.40 | 0.047 | 0.055 | |
| е | 0.95 BSC | | 0.0374 Ref | | |
| e ₁ | 1.90 BSC | | 0.0748 Ref | | |
| L | 0.40 | 0.60 | 0.016 | 0.024 | |
| L ₁ | 0.64 Ref | | 0.025 Ref | | |
| S | 0.50 Ref | | 0.020 Ref | | |
| q | 3° | 8° | 3° | 8° | |

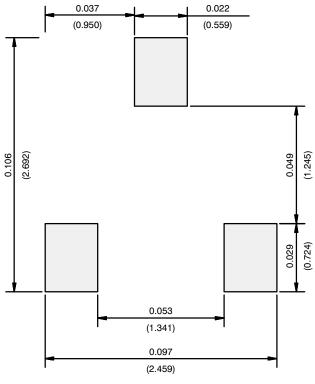
ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

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RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR
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